# Using the TPS53317AEVM-726

# **User's Guide**



Literature Number: SLUUBD2 November 2015



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# TPS53317AEVM-726 D-CAP+™ Mode Synchronous Step-Down Integrated FETs Converter

#### 1 Introduction

The TPS53317AEVM-726 evaluation module (EVM) is a synchronous buck regulator featuring TPS53317A. The TPS53317A is a fully integrated synchronous buck regulator employing D-CAP+™ technology.

### 2 Description

The TPS53317AEVM-726 is designed to use a 1.2-V voltage rail to produce a regulated 0.6-V output at up to 6-A load current. The TPS53317AEVM-726 is designed to demonstrate the TPS53317A in a typical low voltage application while providing a number of test points to evaluate the performance of the TPS53317A.

### 2.1 Typical Applications

- VTT terminators
- · Low-voltage applications for 0.9-V to 6-V step-down rails

#### 2.2 Features

The TPS53317AEVM-726 features:

- Integrated droop support
- External tracking support
- Selectable switching frequency settings (600 kHz and 1 MHz)
- Selectable light-load operation modes (auto-skip and forced CCM)
- Selectable valley overcurrent limit
- PGOOD function
- Convenient test points for probing critical waveforms



### 3 Electrical Performance Specifications

Table 1 contains the TPS53317AEVM-726 electrical performance specifications.

Table 1. TPS53317AEVM-726 Electrical Performance Specifications<sup>(1)</sup>

Parameter	Test Conditions	MIN	TYP	MAX	Units	
Input Characteristics						
Voltage range	V <sub>IN</sub>	1.1	1.2	1.3	V	
Maximum input current	V <sub>IN</sub> = 1.2 V, I <sub>OUT</sub> = 6 A		3.8		Α	
No load input current	$V_{IN}$ = 1.2 V, $I_{OUT}$ = 0 A under PWM mode, $f_{SW}$ = 600 kHz		25		mA	
Output Characteristics	,					
Output voltage			0.6		V	
	Setpoint accuracy (V <sub>IN</sub> = 1.2 V, I <sub>OUT</sub> = 0 A, non-droop)	-2%		2%		
Output voltage regulation	Line regulation ( $V_{IN}$ = 1.1 V – 1.3 V, $I_{OUT}$ = 6 A, non-droop, $f_{SW}$ = 600 kHz)			0.1%		
	Load regulation, ( $V_{IN}$ = 1.2 V, $I_{OUT}$ = 0 A - 6 A, non-droop, $f_{SW}$ = 600 kHz)			0.5%		
Output voltage ripple	V <sub>IN</sub> = 1.2 V, I <sub>OUT</sub> = 6 A		10		mVpp	
Output load current		0		6	۸	
Over current limit valley			7.6/5.4		Α	
Systems Characteristics				<del>"</del>		
Switching frequency			600/1000		kHz	
Peak efficiency	$V_{\rm IN}$ = 1.2 V, $I_{\rm OUT}$ = 1.6 A under PWM mode, $f_{\rm SW}$ = 600 kHz		86.9%			
Full load efficiency	$V_{IN}$ = 1.2 V, $I_{OUT}$ = 6 A under PWM mode, $f_{SW}$ = 600 kHz		78.9%			
Operating temperature			25		٥C	

<sup>(1)</sup> Jumpers set to default locations, See Section 6 of this user's guide



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### 4 Schematic

Figure 1 illustrates the EVM schematic.

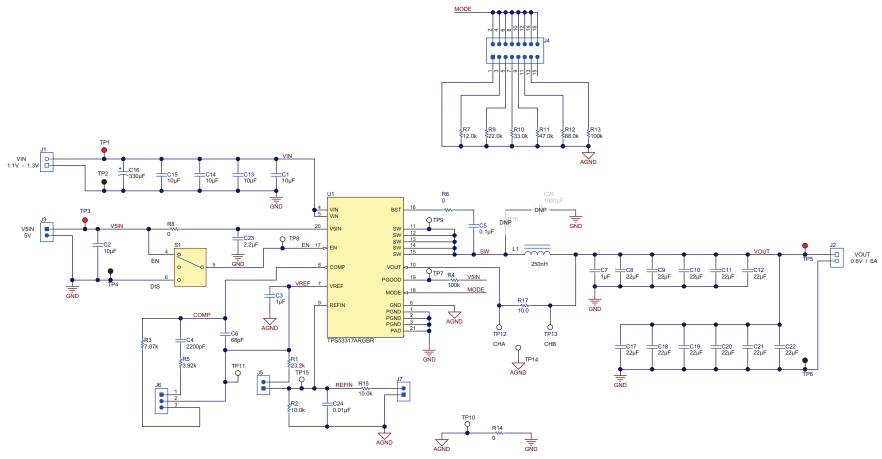


Figure 1. TPS53317AEVM-726 Schematic

Schematic



Test Setup www.ti.com

### 5 Test Setup

### 5.1 Test Equipment

#### **Voltage Source:**

- VIN: The input voltage source VIN should be a 0-V to 6-V variable DC source capable of supplying 8
   Apc. Connect VIN to J1 as shown in Figure 3.
- V5IN: The V5IN voltage source should be a 5-V DC source capable of supplying 1 A<sub>DC</sub>. Connect V5IN to J3 as shown in Figure 3.

#### **Multimeters:**

- V1: VIN at TP1 (VIN) and TP2 (PGND), 0-V to 6-V voltmeter
- V2: V5IN at TP3 (V5IN) and TP4 (PGND)
- V3: VOUT at TP5 (VOUT) and TP6 (PGND)
- A1: VIN input current, 0 A<sub>DC</sub> to 8 A<sub>DC</sub> Ammeter

**Output Load:** The output load should be an electronic constant resistance mode load capable of 0  $A_{DC}$  to 10  $A_{DC}$ 

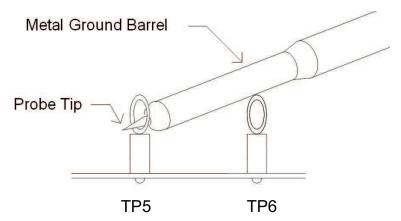


Figure 2. Tip and Barrel Measurement for VOUT Ripple

**Fan:** Some of the components in this EVM may approach temperatures of 55°C during operation. A small fan capable of 200 LFM to 400 LFM is recommended to reduce component temperatures while the EVM is operating. The EVM should not be probed while the fan is not running.

#### **Recommended Wire Gauge:**

- VIN to J1 (1.2-V input): The recommended wire size is 1x AWG #14 per input connection, with the total length of wire less than 4 feet (2 feet input, 2 feet return).
- **J2 to LOAD:** The minimum recommended wire size is 1x AWG #14, with the total length of wire less than 4 feet (2-feet output, 2-feet return)
- **V5IN to J3 (5-V input):** The recommended wire size is 1x AWG #16 per input connection, with the total length of wire less than 4 feet (2-feet input, 2-feet return).



www.ti.com Test Setup

#### 5.2 Recommended Test Setup

Figure 3 is the recommended test set up to evaluate the TPS53317AEVM-726. Working at an ESD workstation, make sure that any wrist straps, bootstraps or mats are connected referencing the user to earth ground before power is applied to the EVM.

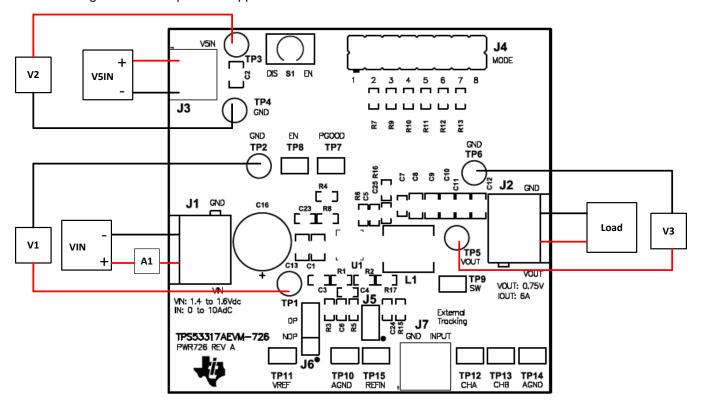


Figure 3. TPS53317AEVM-726 Recommended Test Set Up

#### **Input Connections:**

- 1. Prior to connecting the DC input source VIN, it is advisable to limit the source current from VIN to 8 A maximum. Make sure VIN is initially set to 0 V and connected to J1 as shown in Figure 3.
- 2. Connect a current meter A1 between VIN and J1 to measure the input current.
- 3. Connect a voltmeter V1 at TP1 (VIN) and TP2 (PGND) to measure the input voltage.
- 4. Prior to connecting the 5-V DC source V5IN, it is advisable to limit the source current from V5IN to 1 A maximum. Make sure V5IN is initially set to 0 V and connected to J3 as shown in Figure 3.
- 5. Connect a voltmeter V2 at TP3 (V5IN) and TP4 (PGND) to measure the V5IN voltage.

#### **Output Connections:**

- 1. Connect Load to J2 and set Load to constant resistance mode to sink 0 A<sub>DC</sub> before VIN is applied.
- 2. Connect a voltmeter V3 at TP5 (VOUT) and TP6 (PGND) to measure the output voltage.

**Other Connections:** Place a Fan as shown in Figure 3 and turn on, making sure air is flowing across the EVM.



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### 6 Configurations

All Jumper selections should be made prior to applying power to the EVM. User can configure this EVM per following configurations.

#### 6.1 Mode Selection

The MODE can be set by J4.

### 6.1.1 Default setting: MODE5

**Table 2. MODE Selection** 

Jumper Setting	Mode	Mode Resistances (kΩ)	Light-Load Power- Saving Mode	Switching Frequency (kHz)	Overcurrent Limit (OCL) Valley (A)
1 <sup>st</sup> (1-2 pin shorted)	1	0		600	7.6
2 <sup>nd</sup> (3-4 pin shorted)	2	12	Ckin	600	5.4
3 <sup>rd</sup> (5-6 pin shorted)	3	22	Skip	1000	5.4
4 <sup>th</sup> (7-8 pin shorted)	4	33		1000	7.6
5 <sup>th</sup> (9-10 pin shorted)	5	47		600	7.6
6 <sup>th</sup> (11-12 pin shorted)	6	68	PWM	600	5.4
7 <sup>th</sup> (13-14 pin shorted)	7	100	FVVIVI	1000	5.4
8 <sup>th</sup> (15-16 pin shorted)	8 Onen			1000	7.6

### 6.2 Droop/Non-Droop Configuration

The droop function can be configured by J6.

### 6.2.1 Default Setting: Non-Droop

**Table 3. Droop Configuration** 

Jumper Setting	Droop Configuration
Top(1-2 pin shorted)	Droop
Bottom(2-3 pin shorted)	Non-droop



www.ti.com Configurations

### 6.3 External Tracking Selection

The external tracking can be configured by J5. If jumper J5 is shorted, the internal 2-V VREF voltage is used to set the target output voltage to be 0.6 V. If jumper J5 is open, the external reference between 0.9 V to 4.0 V can be applied to J7. The output voltage will be regulated to ½ of the external reference voltage. For example, applying 1.5 V to J7, the output voltage is 0.75 V.

### 6.3.1 Default setting: No External Tracking

**Table 4. External Tracking Configuration** 

Jumper Setting	External Tracking Configuration
Short	No external tracking
Open	External tracking

#### 6.4 Enable Selection

The controller can be enabled and disabled by S1.

#### 6.4.1 Default setting: Switch to disable the controller

**Table 5. Enable Selection** 

Switch Setting	Enable Selection
DIS	Disable the controller
EN	Enable the controller

#### 7 Test Procedure

### 7.1 Line/Load Regulation and Efficiency Measurement Procedure

- 1. Set up EVM as described in Figure 3.
- 2. Ensure Load is set to constant resistance mode and to sink 0 A<sub>DC</sub>.
- 3. Ensure all jumpers and switch configuration settings per Section 6.
- 4. Increase V5IN from 0 V to 5 V. Using V2 to measure V5IN voltage.
- 5. Increase VIN from 0 V to 1.2 V. Using V1 to measure VIN voltage.
- 6. Set switch S1 to EN to enable the controller.
- 7. Use V3 to measure VOUT voltage, A1 to measure VIN current.
- 8. Vary Load from 0  $A_{DC}$  to 6  $A_{DC}$ , VOUT should remain in load regulation.
- 9. Vary VIN from 1.1 V to 1.3 V, VOUT should remain in line regulation.
- 10. Set switch S1 to DIS to disable the controller.
- 11. Decrease Load to 0 A.
- 12. Decrease VIN to 0 V.
- 13. Decrease V5IN to 0 V.



Test Procedure www.ti.com

### 7.2 Control Loop Gain and Phase Measurement Procedure

TPS53317AEVM-726 contains a  $10-\Omega$  series resistor in the feedback loop for loop response analysis.

- 1. Set up EVM as described in Figure 3.
- 2. Connect isolation transformer to test points marked TP12 and TP13.
- 3. Connect input signal amplitude measurement probe (channel A) to TP12. Connect output signal amplitude measurement probe (channel B) to TP13.
- 4. Connect ground lead of channel A and channel B to TP14.
- 5. Inject around 40 mV or less signal through the isolation transformer.
- 6. Sweep the frequency from 100 Hz to 1 MHz with 10 Hz or lower post filter. The control loop gain and phase margin can be measured.
- 7. Disconnect isolation transformer from bode plot test points before making other measurements (signal injection into feedback may interfere with accuracy of other measurements).

#### 7.3 List of Test Points

**Table 6. The Functions of Each Test Points** 

Test Points	Name	Description	
TP1	VIN	Input voltage	
TP2	PGND	PGND for VIN	
TP3	V5IN	5-V power supply for analog circuits and gate drive	
TP4	PGND	PGND for V5IN	
TP5	VOUT	Output voltage	
TP6	PGND	PGND for VOUT	
TP7	PGOOD	Power good	
TP8	EN	Enable pin	
TP9	SW	Switching node	
TP10	AGND	AGND Signal ground	
TP11	VREF	Internal 2-V reference voltage output	
TP12	CHA	Input A for loop injection	
TP13	СНВ	Input B for loop injection	
TP14	AGND	Signal ground	
TP15	REFIN	Target output voltage input	

#### 7.4 Equipment Shutdown

- 1. Shut down VIN
- 2. Shut down V5IN
- 3. Shut down Load
- 4. Shut down FAN



### 8 Performance Data and Typical Characteristic Curves

Figure 4 through Figure 15 present typical performance curves for TPS53317AEVM-726.

### 8.1 Efficiency

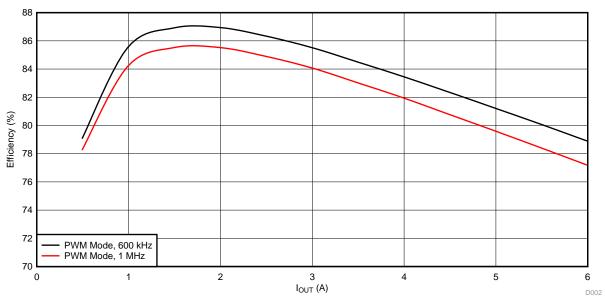


Figure 4. Efficiency

### 8.2 Load Regulation

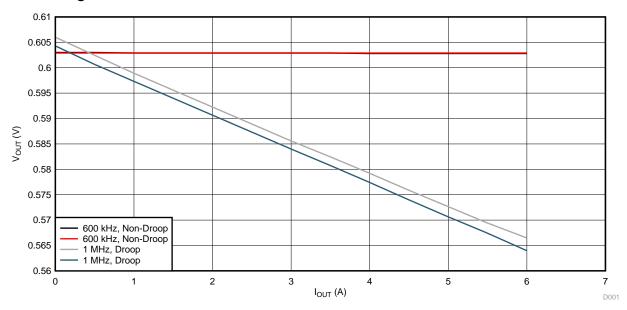


Figure 5. Load Regulation



### 8.3 Output Transient

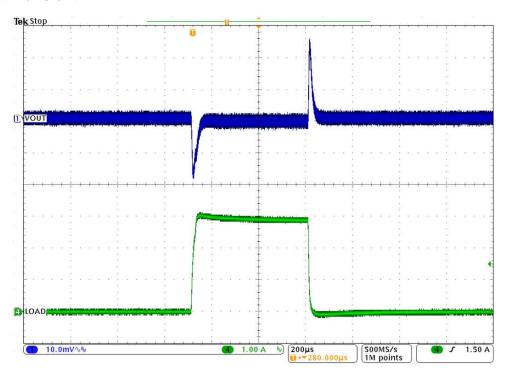


Figure 6. Output Load 0-A to 3-A Transient (1.2-V  $V_{\rm IN}$ , 0.6-V  $V_{\rm OUT}$ , PWM Mode,  $f_{\rm SW}$  = 600 kHz)

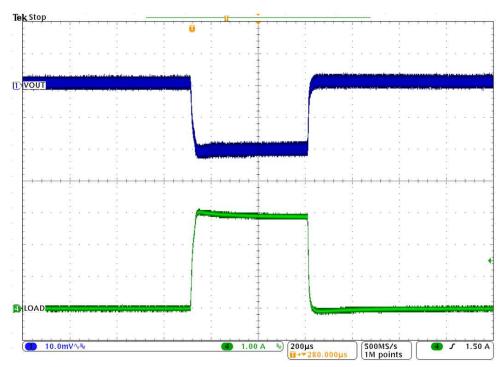


Figure 7. Output Load 0-A to 3-A Transient with Droop (1.2-V  $V_{\rm IN}$ , 0.6-V  $V_{\rm OUT}$ , PWM Mode,  $f_{\rm SW}$  = 600 kHz)



### 8.4 Output Ripple

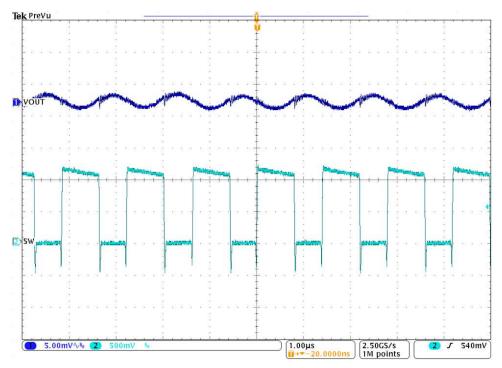


Figure 8. Output Ripple (1.2-V  $V_{\text{IN}}$ , 0.6-V  $V_{\text{OUT}}$ , 3-A  $I_{\text{OUT}}$ ,  $f_{\text{SW}}$  = 600 kHz)

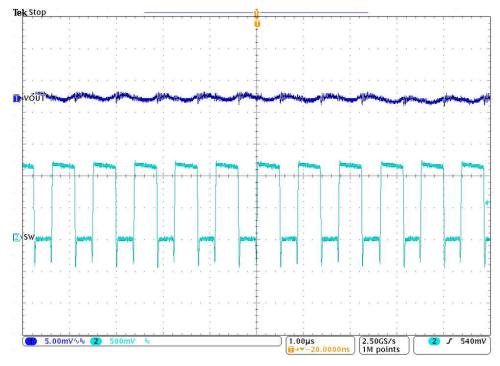


Figure 9. Output Ripple (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ ,  $f_{SW}$  = 1 MHz)



### 8.5 Switching Node

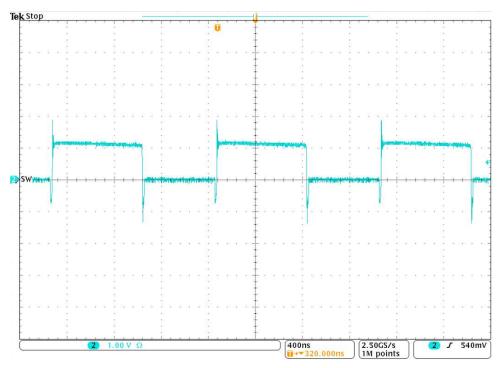


Figure 10. Switching Node (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ ,  $f_{SW}$  = 600 kHz)

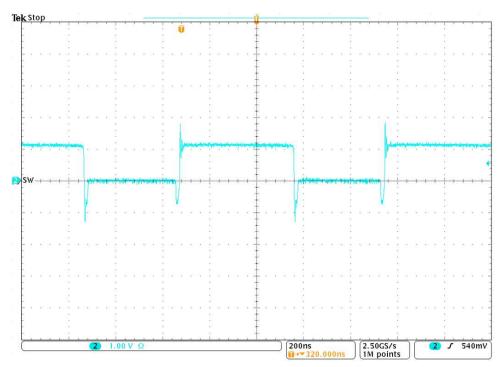


Figure 11. Switching Node (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ ,  $f_{SW}$  = 1 MHz)



### 8.6 Enable Turn On / Turn Off

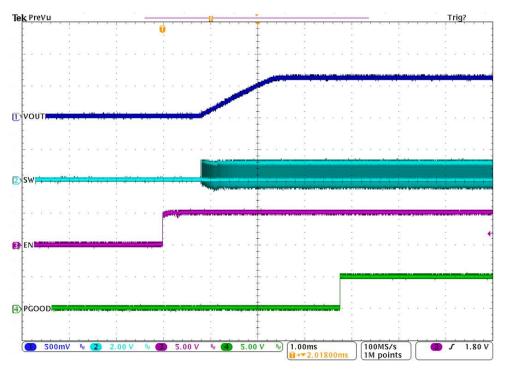


Figure 12. Turn-On Waveform (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ )

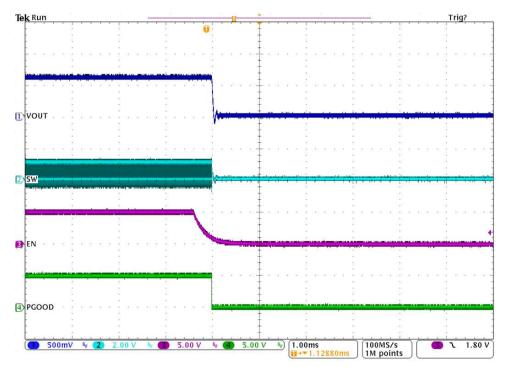


Figure 13. Turn-Off Waveform (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ )



### 8.7 Pre-Bias Turn-On

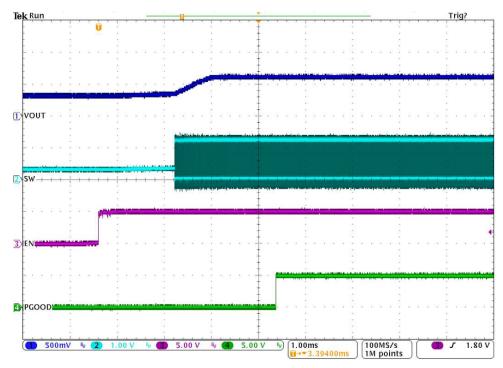


Figure 14. Pre-Bias Turn-On Waveform (1.2-V  $V_{\text{IN}}$ , 0.6-V  $V_{\text{OUT}}$ , 0-A  $I_{\text{OUT}}$ , 0.3-V Pre-Bias)

### 8.8 Bode Plot

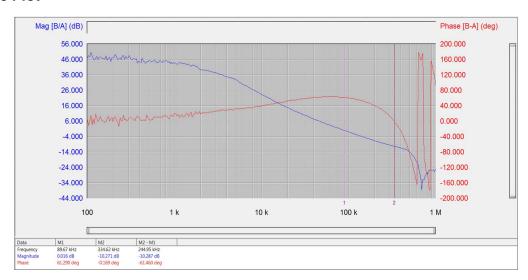


Figure 15. Loop Gain (1.2-V  $V_{IN}$ , 0.6-V  $V_{OUT}$ , 3-A  $I_{OUT}$ , PWM Mode,  $f_{SW}$  = 600 kHz, Non-Droop)



### 8.9 Thermal Image

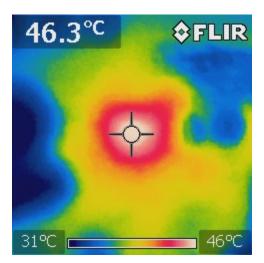


Figure 16. Thermal Image (1.2-V  $V_{\text{IN}}$ , 0.6-V  $V_{\text{OUT}}$ , 6-A  $I_{\text{OUT}}$ , PWM Mode,  $f_{\text{SW}}$  = 600 kHz)



### 9 EVM Assembly Drawing and PCB Layout

The following figures (Figure 17 through Figure 22) show the design of the TPS53317AEVM-726 printed circuit board. The EVM has been designed using 4-Layers, 2-oz copper circuit board.

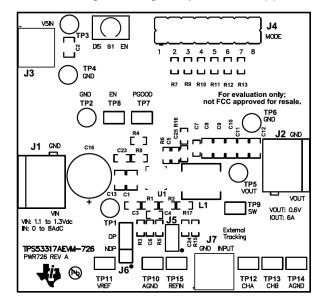


Figure 17. TPS53317AEVM-726 Top Layer Assembly Drawing (Top View)

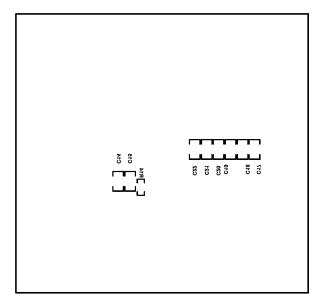


Figure 18. TPS53317AEVM-726 Bottom Assembly Drawing (Bottom View)



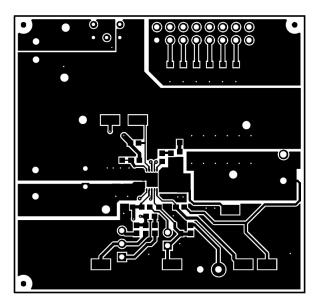


Figure 19. TPS53317AEVM-726 Top Copper (Top View)

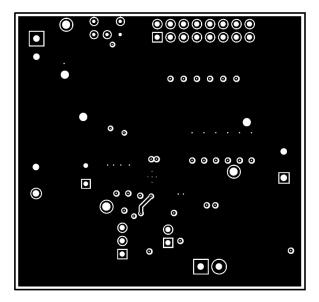


Figure 20. TPS53317AEVM-726 Layer 2 (Top View)



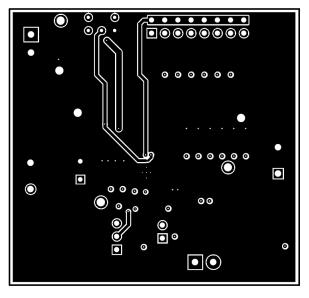


Figure 21. TPS53317AEVM-726 Layer 3 (Top View)

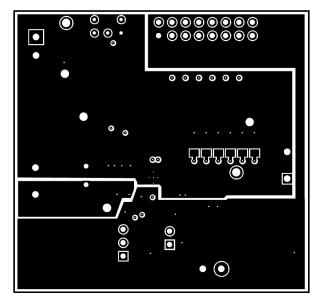


Figure 22. TPS53317AEVM-726 Bottom Layer (Top View)



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### 10 List of Materials

The EVM components list according to the schematic shown in Figure 1.

### Table 7. TPS53317AEVM-726 List of Materials

Qty	Designator	Description	Part Number	Manufactur er
4	C1, C13, C14, C15	CAP, CERM, 10 μF, 16 V, +/- 10%, X5R, 0805	STD	STD
1	C2	CAP, CERM, 10 μF, 10 V, +/- 10%, X5R, 0805	STD	STD
2	C3, C7	CAP, CERM, 1 μF, 25 V, +/- 10%, X5R, 0603	STD	STD
1	C4	CAP, CERM, 2200 pF, 16 V, +/- 10%, X7R, 0603	STD	STD
1	C5	CAP, CERM, 0.1 µF, 25 V, +/- 10%, X7R, 0603	STD	STD
1	C6	CAP, CERM, 68 pF, 50 V, +/- 5%, C0G/NP0, 0603	STD	STD
11	C8, C9, C10, C11, C12, C17, C18, C19, C20, C21, C22	CAP, CERM, 22 μF, 6.3 V, +/- 20%, X5R, 0805	STD	STD
1	C16	CAP, Aluminum Polymer, 330 µF, 10 V, +/- 20%, 0.017 ohm, TH	STD	STD
1	C23	CAP, CERM, 2.2 μF, 10 V, +/- 10%, X5R, 0603	STD	STD
1	C24	CAP, CERM, 0.01 μF, 25 V, +/- 10%, X7R, 0603	STD	STD
2	J1, J2	TERMINAL BLOCK 5.08MM VERT 2POS, TH	ED120/2DS	On-Shore Technology
2	J3, J7	Terminal Block, 6A, 3.5mm Pitch, 2-Pos, TH	ED555/2DS	On-Shore Technology
1	J4	Header, 2.54 mm, 8x2, Tin, Vertical, TH	PEC08DAAN	Sullins Connector Solutions
1	J5	Header, 100mil, 2x1, Tin, TH	PEC02SAAN	Sullins Connector Solutions
1	J6	Header, 100mil, 3x1, Tin, TH	PEC03SAAN	Sullins Connector Solutions
1	L1	Inductor, Shielded, Ferrite, 250 nH, 19.2 A, 0.0023 ohm, SMD	SPM6530T-R25M230	TDK
1	R1	RES, 23.2 k, 1%, 0.1 W, 0603	STD	STD
2	R2, R15	RES, 10.0 k, 1%, 0.1 W, 0603	STD	STD
1	R3	RES, 7.87 k, 1%, 0.1 W, 0603	STD	STD
1	R4	RES, 100 k, 1%, 0.1 W, 0603	STD	STD
1	R5	RES, 3.92 k, 1%, 0.1 W, 0603	STD	STD
3	R6, R8, R14	RES, 0, 5%, 0.1 W, 0603	STD	STD
1	R7	RES, 12.0 k, 1%, 0.1 W, 0603	STD	STD
1	R9	RES, 22.0 k, 1%, 0.1 W, 0603	STD	STD
1	R10	RES, 33.0 k, 1%, 0.1 W, 0603	STD	STD
1	R11	RES, 47.0 k, 1%, 0.1 W, 0603	STD	STD
1	R12	RES, 68.0 k, 1%, 0.1 W, 0603	STD	STD
1	R13	RES, 100 k, 1%, 0.1 W, 0603	STD	STD
1	R17	RES, 10.0, 1%, 0.1 W, 0603	STD	STD
1	S1	Switch, Toggle, SPDT 1Pos, TH	G12AP	NKK Switches
3	SH-J4, SH-J5, SH-J6	Shunt, 100mil, Gold plated, Black	969102-0000-DA	3M
3	TP1, TP3, TP5	Test Point, Multipurpose, Red, TH	5010	Keystone
3	TP2, TP4, TP6	Test Point, Multipurpose, Black, TH	5011	Keystone
9	TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15	Test Point, Miniature, SMT	5015	Keystone



List of Materials www.ti.com

### Table 7. TPS53317AEVM-726 List of Materials (continued)

Qty	Designator	Description	Part Number	Manufactur er
1		6-A Output D-CAP+ Mode Synchronous Step-Down, Integrated-FET Converter for DDR Memory Termination	TPS53317ARGBR	Texas Instruments

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Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than. The EVM is designed to operate properly with certain components above as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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#### **CAUTION**

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Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

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- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

#### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

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#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

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If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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